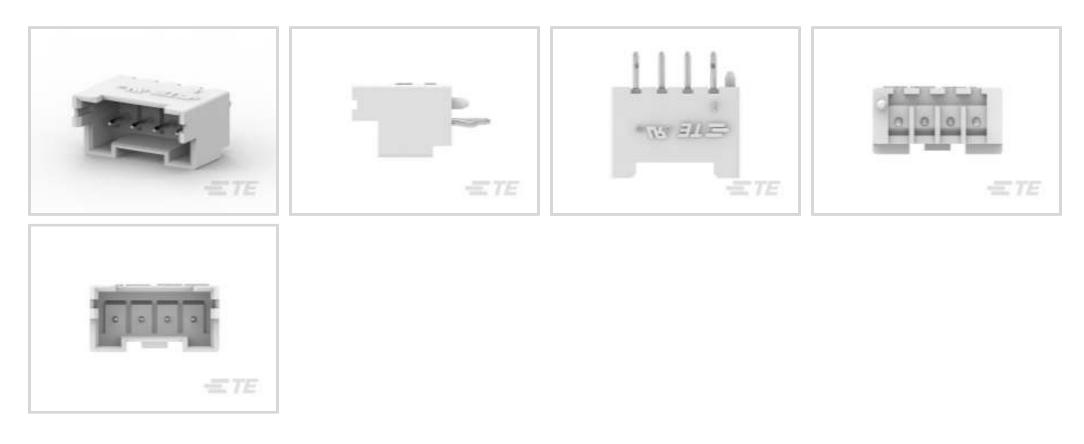


Economy Power 2.5

TE Internal #: 1969730-4 PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 2.5 mm [. 098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Economy Power 2.5

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 4

Number of Rows: 1

Centerline (Pitch): 2.5 mm [.098 in]

PCB Mount Orientation: Vertical

Features

E

Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	4
Number of Rows	1
PCB Mount Orientation	Vertical
Body Features	
Primary Product Color	Natural
Contact Features	
Mating Pin Diameter	.6 mm[.024 in]
Contact Mating Area Plating Material Thickness	2 – 5 µm[80 – 200 µin]

PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Economy Power 2.5



Contact Mating Area Plating Material Finish	Bright
Contact Underplating Material	Nickel
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	4.2 A
Termination Features	
Round Termination Post & Tail Diameter	.6 mm[.024 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
PCB Mount Alignment Type	Locating Posts
Mating Alignment Type	Polarization
Mating Retention	With
PCB Mount Retention Type	Boardlock
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	With
PCB Mount Retention	With

Housing Features

Housing Material	PBT GF
Centerline (Pitch)	2.5 mm[.098 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	Power & Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Type	Bag, Box

Product Compliance

For compliance documentation, visit the product page on TE.com>

PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Economy Power 2.5



EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

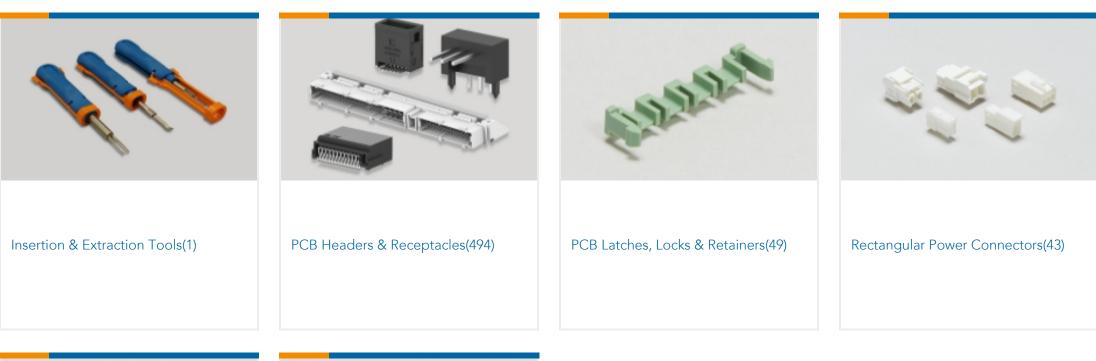


PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Economy Power 2.5





Also in the Series | Economy Power 2.5





Wire-to-Board Connector AssembliesWire-to& Housings(311)

Wire-to-Board Connector Contacts(6)

Customers Also Bought





PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Economy Power 2.5



Documents

Product Drawings EP2.5 SHROUDED HDR ASSY 4P VERTICAL

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1969730-4_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1969730-4_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1969730-4_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English

Product Environmental Compliance MD_1969730-4_073120181351_dmtec

English

MD_1969730-4_073120181351_dmtec

English

Agency Approvals UL Report

English